

SiC

Silicon Carbide Diode

5th Generation thinQ!TM

650V SiC Schottky Diode

IDH06G65C5

Final Datasheet

Rev. 2.2, 2012-12-10

Power Management & Multimarket

5th Generation thinQ!™ SiC Schottky Diode

IDH06G65C5

1 Description

ThinQ!™ Generation 5 represents Infineon leading edge technology for the SiC Schottky Barrier diodes. The Infineon proprietary diffusion soldering process, already introduced with G3 is now combined with a new, more compact design and thin-wafer technology. The result is a new family of products showing improved efficiency over all load conditions, resulting from both the improved thermal characteristics and a lower figure of merit ($Q_c \times V_f$).

The new thinQ!™ Generation 5 has been designed to complement our 650V CoolMOS™ families: this ensures meeting the most stringent application requirements in this voltage range.

Features

- Revolutionary semiconductor material - Silicon Carbide
- Benchmark switching behavior
- No reverse recovery/ No forward recovery
- Temperature independent switching behavior
- High surge current capability
- Pb-free lead plating; RoHS compliant
- Qualified according to JEDEC¹⁾ for target applications
- Breakdown voltage tested at 14 mA²⁾
- Optimized for high temperature operation

Benefits

- System efficiency improvement over Si diodes
- System cost / size savings due to reduced cooling requirements
- Enabling higher frequency / increased power density solutions
- Higher system reliability due to lower operating temperatures
- Reduced EMI

Applications

- Switch mode power supply
- Power factor correction
- Solar inverter
- Uninterruptible power supply

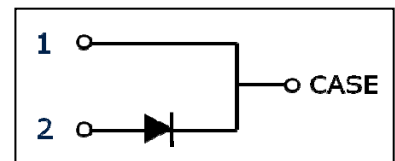
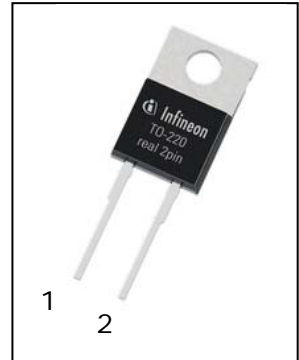


Table 1 Key Performance Parameters

| Parameter | Value | Unit |
|---------------------------|-------|---------|
| V_{DC} | 650 | V |
| $Q_C; V_R=400V$ | 10 | nC |
| $E_C; V_R=400V$ | 2.1 | μJ |
| $I_F @ T_C < 145^\circ C$ | 6 | A |

Table 2 Pin Definition

| Pin 1 | Pin 2 | Pin 3 |
|-------|-------|-------|
| C | A | n.a. |

| Type / ordering Code | Package | Marking | Related links |
|----------------------|------------|---------|----------------------------------------------------------------|
| IDH06G65C5 | PG-TO220-2 | D0665C5 | www.infineon.com/sic |

1) J-STD20 and JESD22

2) All devices tested under avalanche conditions for a time periode of 10ms

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2 Maximum ratings

Table 3 Maximum ratings

| Parameter | Symbol | Values | | | Unit | Note/Test Condition |
|-----------------------------------------------------|----------------|--------|------|------|------------------|--------------------------------------------------|
| | | Min. | Typ. | Max. | | |
| Continuous forward current | I_F | – | – | 6 | A | $T_C < 145^\circ\text{C}$, $D=1$ |
| Surge non-repetitive forward current, sine halfwave | $I_{F,SM}$ | – | – | 54 | | $T_C = 25^\circ\text{C}$, $t_p=10\text{ ms}$ |
| | | – | – | 48 | | $T_C = 150^\circ\text{C}$, $t_p=10\text{ ms}$ |
| Non-repetitive peak forward current | $I_{F,max}$ | – | – | 291 | | $T_C = 25^\circ\text{C}$, $t_p=10\ \mu\text{s}$ |
| i^2t value | $\int i^2 dt$ | – | – | 14 | A ² s | $T_C = 25^\circ\text{C}$, $t_p=10\text{ ms}$ |
| | | – | – | 11 | | $T_C = 150^\circ\text{C}$, $t_p=10\text{ ms}$ |
| Repetitive peak reverse voltage | V_{RRM} | – | – | 650 | V | $T_j = 25^\circ\text{C}$ |
| Diode dv/dt ruggedness | dv/dt | – | – | 100 | V/ns | $V_R=0..480\text{ V}$ |
| Power dissipation | P_{tot} | – | – | 62 | W | $T_C = 25^\circ\text{C}$ |
| Operating and storage temperature | $T_j; T_{stg}$ | -55 | – | 175 | °C | |
| Mounting torque | | – | – | 70 | Ncm | M3 screws |

3 Thermal characteristics

Table 4 Thermal characteristics TO-220-2

| Parameter | Symbol | Values | | | Unit | Note/Test Condition |
|------------------------------------------------------------|------------|--------|------|------|------|--------------------------------------|
| | | Min. | Typ. | Max. | | |
| Thermal resistance, junction-case | R_{thJC} | – | 1.5 | 2.4 | K/W | leaded |
| Thermal resistance, junction-ambient | R_{thJA} | – | – | 62 | | |
| Soldering temperature, wavesoldering only allowed at leads | T_{sold} | – | – | 260 | °C | 1.6mm (0.063 in.) from case for 10 s |

4 Electrical characteristics

Table 5 Static characteristics

| Parameter | Symbol | Values | | | Unit | Note/Test Condition |
|-----------------------|----------|--------|------|------|---------------|-------------------------------------------------|
| | | Min. | Typ. | Max. | | |
| DC blocking voltage | V_{DC} | 650 | – | – | V | $I_R = 0.11 \text{ mA}, T_j = 25^\circ\text{C}$ |
| Diode forward voltage | V_F | – | 1.5 | 1.7 | | $I_F = 6 \text{ A}, T_j = 25^\circ\text{C}$ |
| | | – | 1.8 | 2.1 | | $I_F = 6 \text{ A}, T_j = 150^\circ\text{C}$ |
| Reverse current | I_R | – | 0.3 | 110 | μA | $V_R = 650 \text{ V}, T_j = 25^\circ\text{C}$ |
| | | – | 0.08 | 38 | | $V_R = 600 \text{ V}, T_j = 25^\circ\text{C}$ |
| | | – | 1.2 | 750 | | $V_R = 650 \text{ V}, T_j = 150^\circ\text{C}$ |

Table 6 AC characteristics

| Parameter | Symbol | Values | | | Unit | Note/Test Condition |
|-------------------------|--------|--------|------|------|------|--------------------------------------------------------------------------------------------------------|
| | | Min. | Typ. | Max. | | |
| Total capacitive charge | Q_c | – | 10 | – | nC | $V_R = 400 \text{ V}, di/dt = 200 \text{ A}/\mu\text{s}, I_F \leq I_{F,MAX}, T_j = 150^\circ\text{C}.$ |
| Total Capacitance | C | – | 190 | – | pF | $V_R = 1 \text{ V}, f = 1 \text{ MHz}$ |
| | | – | 25 | – | | $V_R = 300 \text{ V}, f = 1 \text{ MHz}$ |
| | | – | 24 | – | | $V_R = 600 \text{ V}, f = 1 \text{ MHz}$ |

5 Electrical characteristics diagrams

Table 7

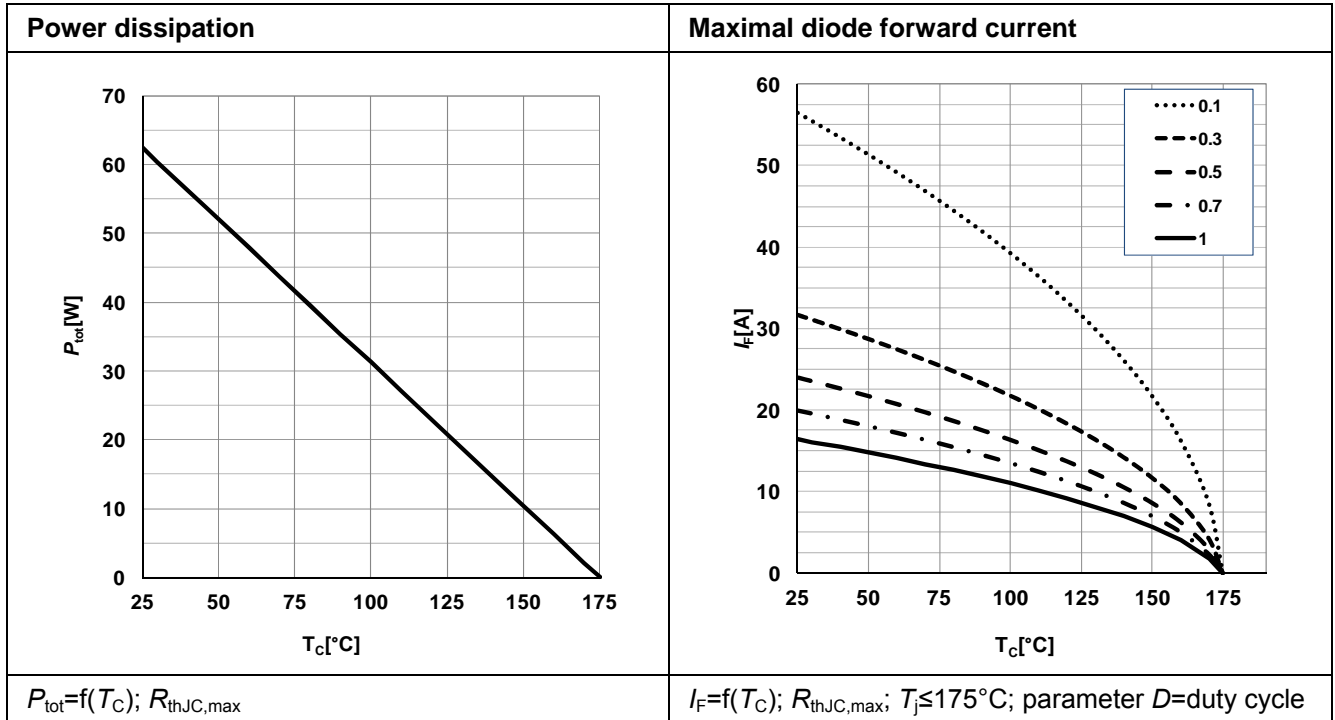


Table 8

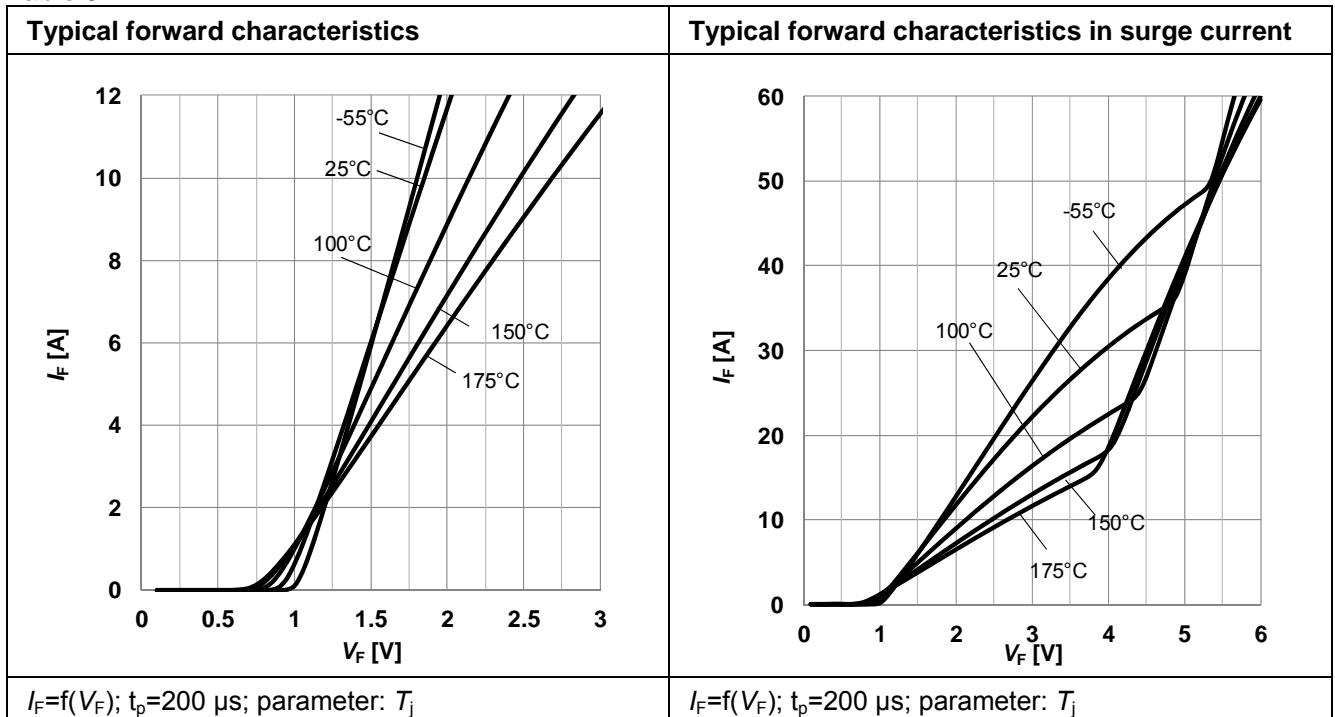
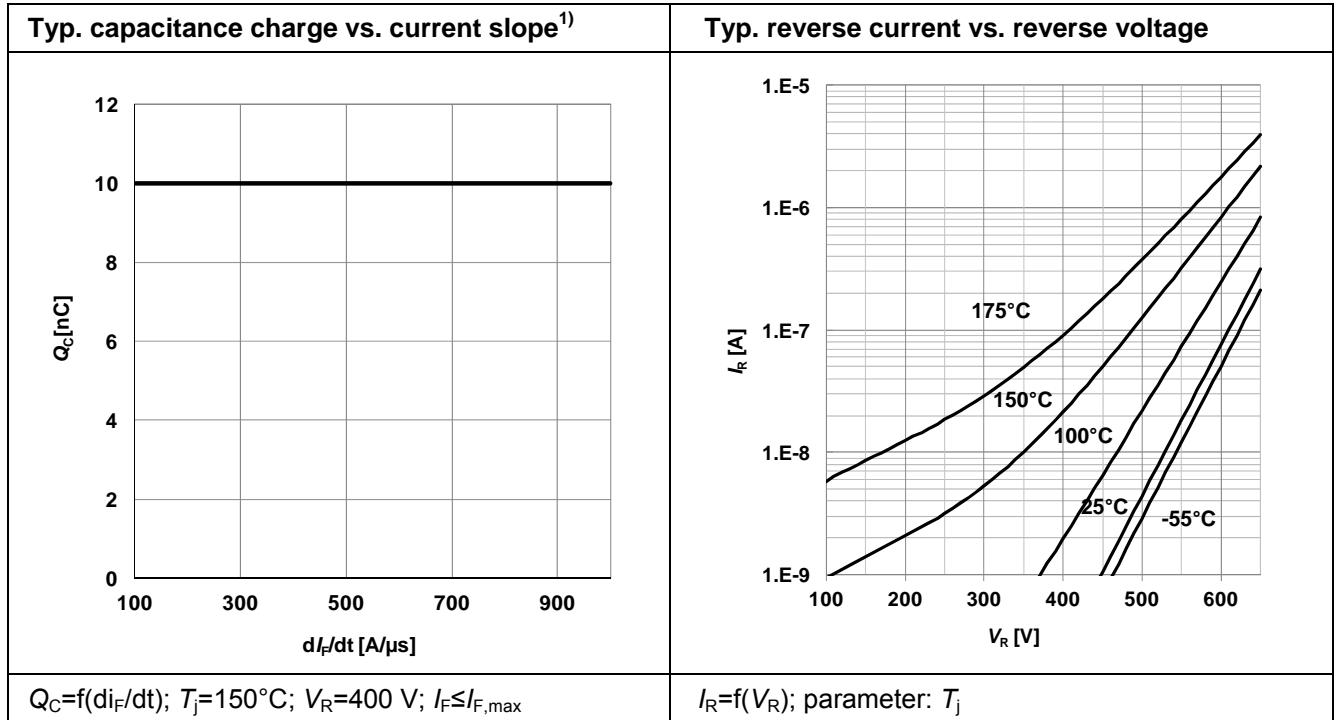


Table 9



1) Only capacitive charge, guaranteed by design.

Table 10

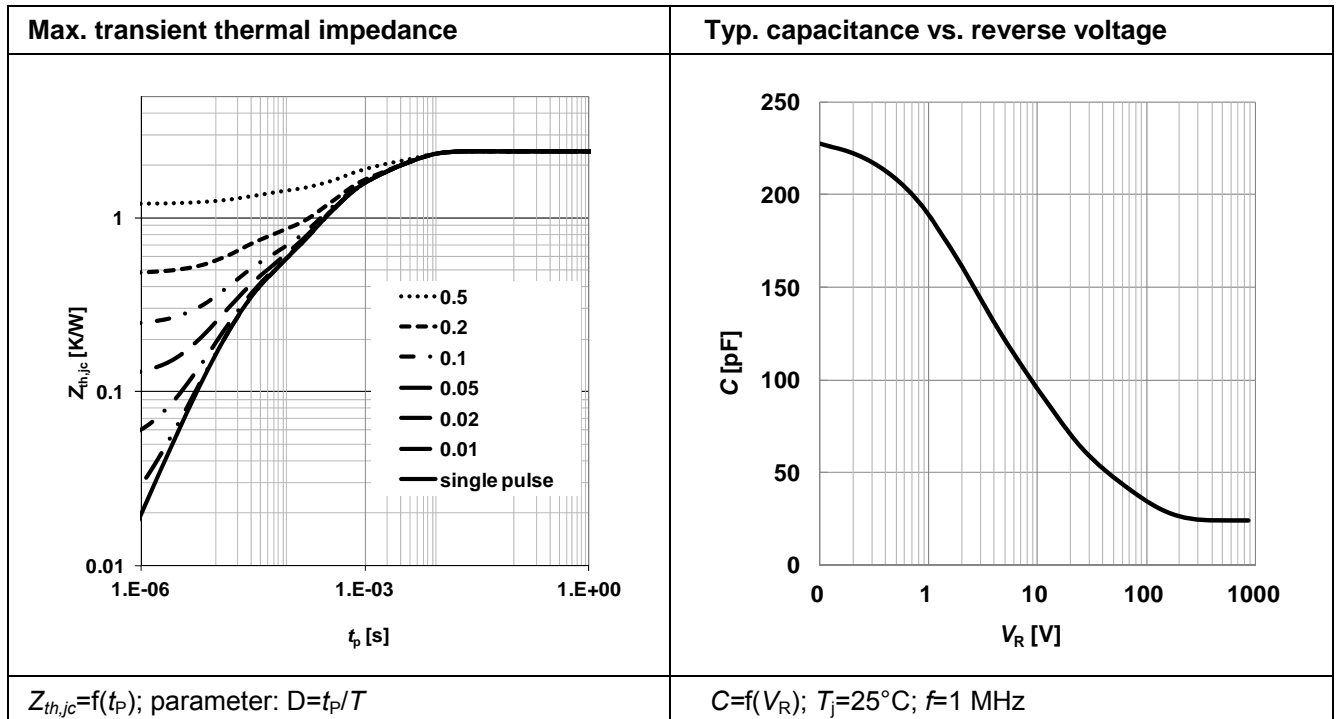
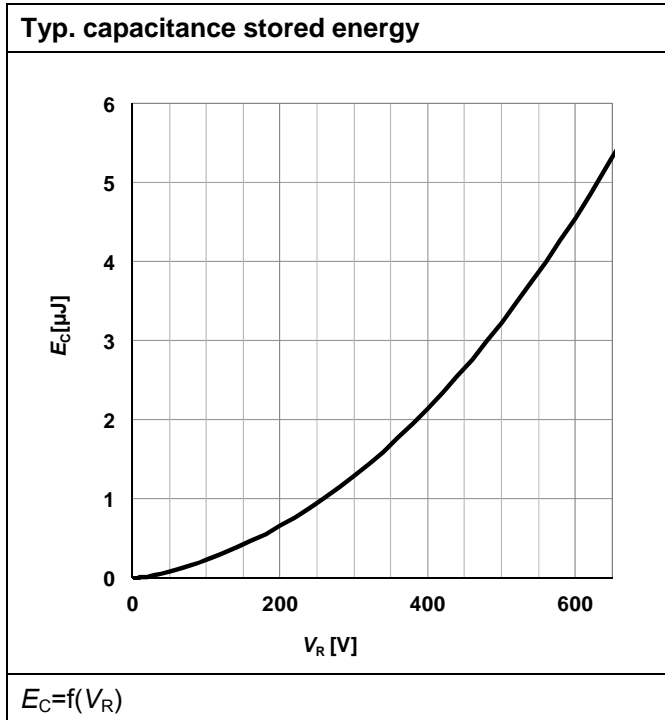


Table 11



6 Simplified Forward Characteristics Model

Table 12

| Equivalent forward current curve | Mathematical Equation |
|----------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| | $V_F = V_{TH} + R_{DIFF} \cdot I_F$ $V_{TH}(T_j) = -0.001 \cdot T_j + 1.04 \text{ [V]}$ $R_{DIFF}(T_j) = 2.13 \cdot 10^{-6} \cdot T_j^2 + 2.13 \cdot 10^{-4} \cdot T_j + 0.077 \text{ [\Omega]}$ |
| $V_F = f(I_F)$ | T_j in °C; $-55^\circ\text{C} < T_j < 175^\circ\text{C}$; $I_F < 12 \text{ A}$ |

7 Package outlines

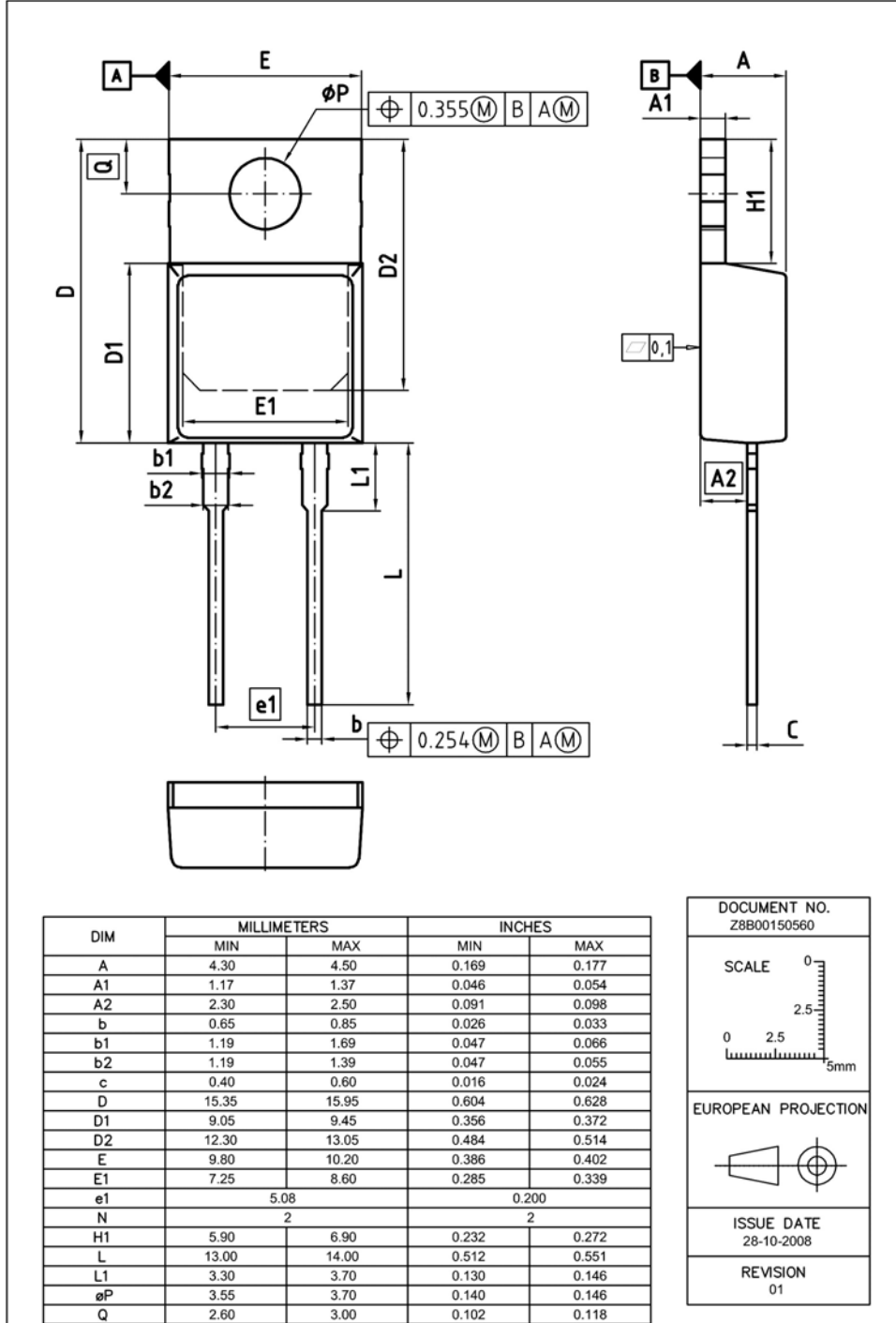


Figure 1 Outlines TO-220, dimensions in mm/inches

8 Revision History

5th. Generation thinQ!™ SiC Schottky Diode

Revision History: 2012-12-10, Rev. 2.2

Previous Revision:

| Revision | Subjects (major changes since last version) |
|----------|--------------------------------------------------------------------------------|
| 2.0 | Release of the final datasheet. |
| 2.1 | Reverse current values, maximum diode forward voltage. |
| 2.2 | Reverse current values, tested avalanche current, simplified calculation model |

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